

Description

The FDD8445 uses advanced trench technology

to provide excellent $\mathsf{R}_{\mathsf{DS}(\mathsf{ON})},$ low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 40V I_D =60A

 $R_{DS(ON)} < 8.5m\Omega @ V_{GS}=10V$

Application

Battery protection

Load switch Uninterruptible power supply

Package Marking and Ordering Information

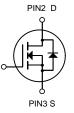
Product ID	Pack	Brand	Qty(PCS)
FDD8445	TO-252-2L	HXY MOSFET	2500

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

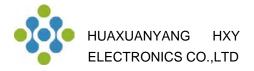
Symbol	Symbol Parameter		Units	
Vds	Drain-Source Voltage	40	V	
Vgs	Gate-Source Voltage	±20	V	
I⊳@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	60	А	
I₀@Tc=100°C	Continuous Drain Current, V _{GS} @ 10V ¹	Continuous Drain Current, V _{GS} @ 10V ¹ 45		
Ідм	Pulsed Drain Current ²	Pulsed Drain Current ² 220		
EAS	Single Pulse Avalanche Energy3416.1		mJ	
las	Avalanche Current	Avalanche Current 39		
P _D @T _C =25°C	Total Power Dissipation ⁴	64.6	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
Reja	Thermal Resistance Junction-ambient (Steady State) ¹	62	°C/W	
Rejc	Thermal Resistance Junction-Case ¹	ermal Resistance Junction-Case ¹ 2.8		







N-Channel MOSFET



Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	L					1	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40	45	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)	I		_				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.2	1.6	2.0	V	
Drain Source On State Desistence	P	V _{GS} =10V, I _D =20A	-	7.0	8.5	- mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A		15	18		
Forward Transconductance	g fs	V _{DS} =10V,I _D =20A		-	-	S	
Dynamic Characteristics (Note4)	·						
Input Capacitance	C _{lss}	N 00)()/ 0)/	-	1800	-	PF	
Output Capacitance	C _{oss}	$V_{DS}=20V, V_{GS}=0V,$	-	280	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	190	-	PF	
Switching Characteristics (Note 4)	I		-				
Turn-on Delay Time	t _{d(on)}		-	6.4	-	nS	
Turn-on Rise Time	tr	- V _{DD} =20V,I _D =2A,R _L =1Ω	-	17.2	-	nS	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =3Ω	-	29.6	-	nS	
Turn-Off Fall Time	t _f		-	16.8	-	nS	
Total Gate Charge	Qg	N/ 001/1 00A	-	29		nC	
Gate-Source Charge	Q _{gs}	$V_{DS}=20V,I_{D}=20A,$	-	4.5		nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	6.4		nC	
Drain-Source Diode Characteristics	L					1	
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-		1.2	V	
Diode Forward Current (Note 2)	Is		-	-	68	Α	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 20A	-	29	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	26	-	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)					

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

5. E_{AS} condition : Tj=25°C, V_{DD} =20V, V_{G} =10V, L=1mH, Rg=25 Ω ,



V_{GS}=10V

I_D=20A

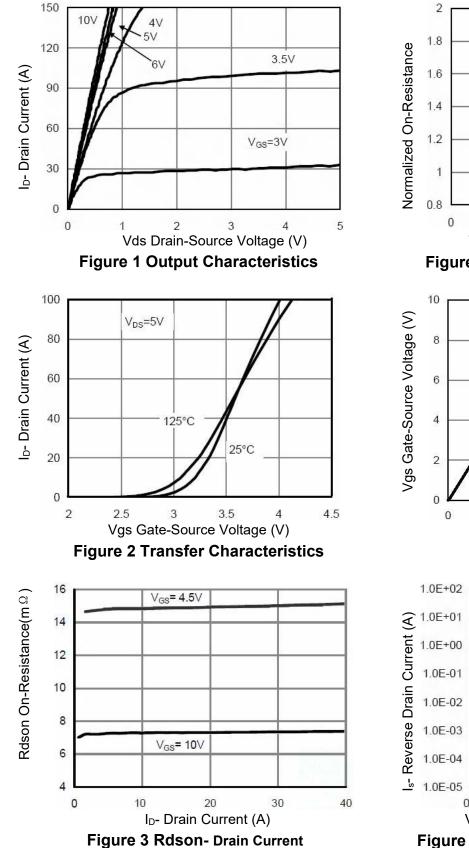
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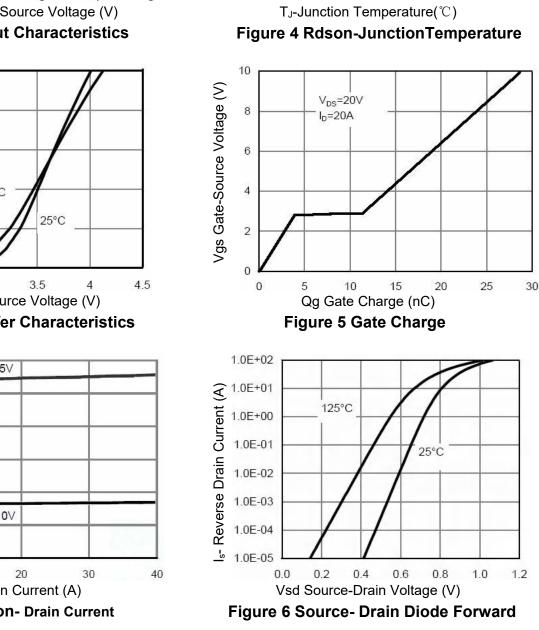
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100 125 150 175

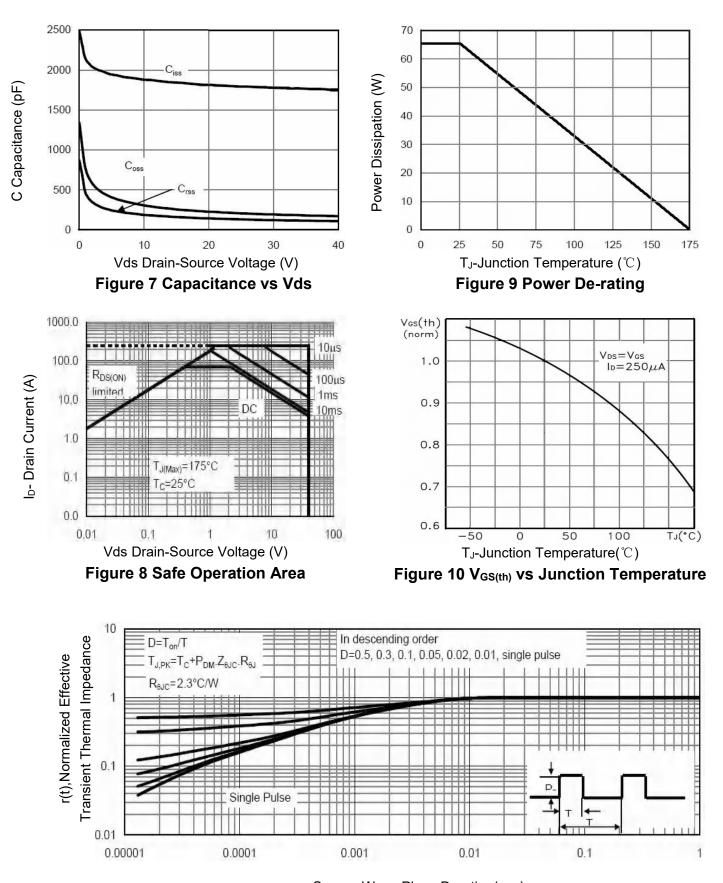
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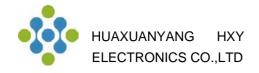
Typical Electrical and Thermal Characteristics (Curves)



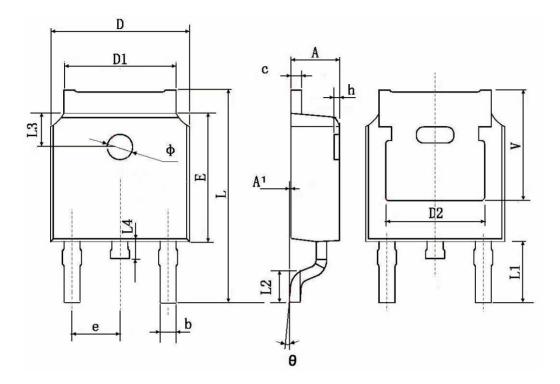




Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252-2L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
с	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.483	3 TYP. 0.190 TYP.		TYP.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067	
L3	1.600	TYP.	0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0 °	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		



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